



# FSA2268 / FSA2268T Low-Voltage Dual-SPDT (0.4Ω) Analog Switch with 16kV ESD

## Features

- 0.4Ω Typical On Resistance ( $R_{ON}$ ) for +3.0V Supply
- 0.25Ω Maximum  $R_{ON}$  Flatness for +3.0V Supply
- -3db Bandwidth: > 50MHz
- Low  $I_{CCT}$  Current Over an Expanded Control Input Range
- Packaged in Pb-free 10-Lead  $\mu$ MLP (1.4 x 1.8mm)
- Power-Off Protection on Common Ports
- Broad  $V_{CC}$  Operating Range: 1.65 to 4.3V
- HBM JEDEC: JESD22-A114
  - I/O to GND: 13.5kV
  - Power to GND: 16.0kV
- Noise Immunity Termination Resistors in FSA2268T

## Description

The FSA2268 is a high-performance, dual Single Pole Double Throw (SPDT) analog switch that features ultra-low  $R_{ON}$  of 0.4Ω (typical) at 3.0V  $V_{CC}$ . The FSA2268 operates over a wide  $V_{CC}$  range of 1.65V to 4.3V and is designed for break-before-make operation. The select input is TTL-level compatible.

The FSA2268 features very low quiescent current even when the control voltage is lower than the  $V_{CC}$  supply. This feature suits mobile handset applications by allowing direct interface with baseband processor general-purpose I/Os with minimal battery consumption.

The FSA2268T includes termination resistors that improve noise immunity during overshoot excursions, off-isolation coupling, or "pop-minimization."

## IMPORTANT NOTE:

For additional information, please contact [analogswitch@fairchildsemi.com](mailto:analogswitch@fairchildsemi.com).

## Applications

- Cell Phone, PDA, Digital Camera, and Notebook
- LCD Monitor, TV, and Set-Top Box

## Ordering Information

Part Number	Top Mark	Eco Status	Package Description
FSA2268UMX	GF	Green	10-Lead, Quad Ultrathin Molded Leadless Package (UMLP), 1.4 x 1.8mm, 0.4mm pitch
FSA2268TUMX	GH	Green	10-Lead, Quad Ultrathin Molded Leadless Package (UMLP), 1.4 x 1.8mm, 0.4mm pitch
FSA2268L10X	GH	Green	10-Lead, MicroPak™, 1.6mm Wide

For Fairchild's definition of Eco Status, please visit: [http://www.fairchildsemi.com/company/green/rohs\\_green.html](http://www.fairchildsemi.com/company/green/rohs_green.html).

## Analog Symbols

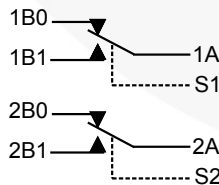


Figure 1. FSA2268

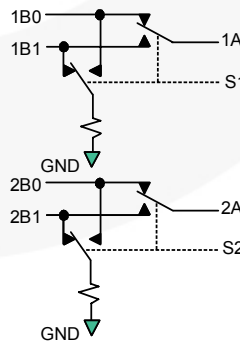


Figure 2. FSA2268T (with Noise Termination Resistors)

### Pin Configuration

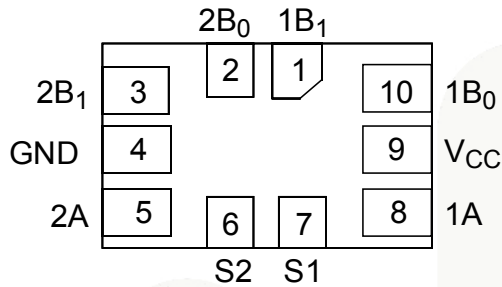


Figure 3. Pin Assignment 10-Pin UMLP (Top-Through View)

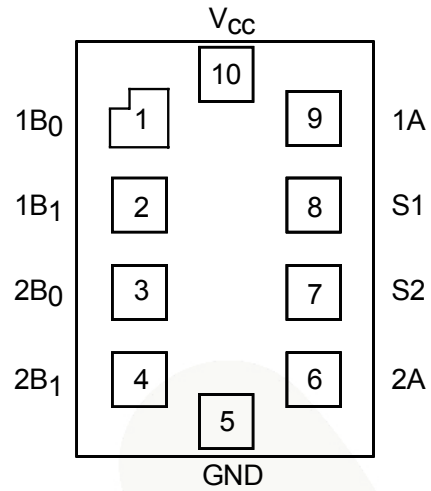


Figure 4. 10-Lead MicroPak™

### Pin Descriptions

Pin # UMLP	Pin # MicroPak™	Name	Description
1	2	1B <sub>1</sub>	Data Ports
2	3	2B <sub>0</sub>	Data Ports
3	4	2B <sub>1</sub>	Data Ports
4	5	GND	Ground
5	6	2A	Data Ports
6	7	S2	Switch Select Pins
7	8	S1	Switch Select Pins
8	9	1A	Data Ports
9	10	V <sub>CC</sub>	Supply Voltage
10	1	1B <sub>0</sub>	Data Ports

### Truth Table

Control Input, S <sub>n</sub>	Function
LOW Logic Level	nB <sub>0</sub> connected to nA (FSA2268/2268T); nB <sub>1</sub> terminated to GND (FSA2268T only)
HIGH Logic Level	nB <sub>1</sub> connected to nA (FSA2268/2268T); nB <sub>0</sub> terminated to GND (FSA2268T only)

## Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Min.	Max.	Units	
V <sub>CC</sub>	Supply Voltage	-0.5	5.5	V	
V <sub>SW</sub>	Switch I/O Voltage <sup>(1)</sup>	1B0, 1B1, 2B0, 2B1, 1A, 2A Pins	-0.5	V <sub>CC</sub> + 0.3	V
		T Version nBn Pin Off	0	1.4	
V <sub>IN</sub>	Control Input Voltage <sup>(1)</sup>	-0.5	5.5	V	
I <sub>IK</sub>	Input Clamp Diode Current		-50	mA	
I <sub>SW</sub>	Switch I/O Current (Continuous)		350	mA	
I <sub>SWPEAK</sub>	Peak Switch Current (Pulsed at 1ms Duration, <10% Duty Cycle)		500	mA	
T <sub>STG</sub>	Storage Temperature Range	-65	+150	°C	
T <sub>J</sub>	Maximum Junction Temperature		+150	°C	
T <sub>L</sub>	Lead Temperature (Soldering, 10 seconds)		+260	°C	
MSL	Moisture Sensitivity Level (JEDEC J-STD-020A)		1	Level	
ESD	Human Body Model, JEDEC: JESD22-A114	I/O to GND		13.5	kV
		Power to GND		16.0	
		All Other Pins		9.0	
	Charged Device Model, JEDEC: JESD22-C101			2.0	kV

**Note:**

- Input and output negative ratings may be exceeded if input and output diode current ratings are observed.

## Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Max.	Units
V <sub>CC</sub>	Supply Voltage	1.65	4.30	V
V <sub>IN</sub>	Control Input Voltage	0	V <sub>CC</sub>	V
V <sub>SW</sub>	Switch I/O Voltage	0	V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature	-40	+85	°C

## DC Electrical Characteristics

All typical values are at 25°C unless otherwise specified.

Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	T <sub>A</sub> =+25°C			T <sub>A</sub> =-40 to +85°C		Unit
				Min.	Typ.	Max.	Min.	Max.	
V <sub>IH</sub>	Input Voltage High		3.6 to 4.3				1.7		V
			2.7 to 3.6				1.5		
			2.3 to 2.7				1.4		
			1.65 to 1.95				0.9		
V <sub>IL</sub>	Input Voltage Low		3.6 to 4.3					0.7	V
			2.7 to 3.6					0.5	V
			2.3 to 2.7					0.4	
			1.65 to 1.95					0.4	
I <sub>IN</sub>	Control Input Leakage (S1,S2)	V <sub>IN</sub> =0 to V <sub>CC</sub>	1.65 to 4.30				-0.5	0.5	μA
I <sub>NO(OFF)</sub> , I <sub>NC(OFF)</sub> FSA2268	Off Leakage Current of Port nB0 and nB1	nA=0.3V, V <sub>CC</sub> =0.3V nB0 or nB1=V <sub>CC</sub> -0.3V, 0.3V, or Floating Figure 6	1.95 to 4.30	-10		10	-50	50	nA
I <sub>NC(OFF)</sub> FSA2268T	Off Leakage Current of Port nB0 and nB1 (with Termination Resistors)	nA=0.3V, nB0 or nB1=0V or Floating Figure 6	1.95 to 4.30	-10		10	-50	50	μA
I <sub>A(ON)</sub>	On Leakage Current of Port nA	nA=0.3V, V <sub>CC</sub> =0.3V nB0 or nB1=V <sub>CC</sub> -0.3V, 0.3V, or Floating Figure 7	1.95 to 4.30	-20		20	-100	100	nA
I <sub>OFF</sub> FSA2268	Power-Off Leakage Current (Common Port Only 1A, 2A)	Common Port (1A, 2A), V <sub>IN</sub> =0V to 4.3V, V <sub>CC</sub> =0V nB0, nB1=Floating	0V					±1	μA
I <sub>OFF</sub> FSA2268T	Power-Off Leakage Current (Common Port Only 1A, 2A)	Common Port (1A, 2A), V <sub>IN</sub> =0V to 4.3V, V <sub>CC</sub> =0V nB0, nB1=0V or Floating	0V					±40	μA
R <sub>ON</sub>	Switch On Resistance <sup>(2)(5)</sup>	I <sub>ON</sub> =100mA, nB0 or nB1=0.7V, 3.6V Figure 5	4.30		0.30			0.50	Ω
		I <sub>ON</sub> =100mA, nB0 or nB1=0.7V, 2.3V Figure 5	3.00		0.40			0.55	
		I <sub>ON</sub> =100mA, nB0 or nB1=0V, 0.7V, 1.6V, 2.3V Figure 5	2.30		0.52				
		I <sub>ON</sub> =100mA, nB0 or nB1=0V, 0.7V, 1.65V Figure 5	1.65		1.00				
ΔR <sub>ON</sub>	On Resistance Matching Between Channels <sup>(3)(5)</sup>	I <sub>ON</sub> =100mA, nB0 or nB1=0.7V	4.30		0.04			0.13	Ω
			3.00		0.06			0.13	
			2.30		0.12				
			1.65		1.00				

Continued on following page...

### DC Electrical Characteristics (Continued)

All typical values are at 25°C unless otherwise specified.

Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	T <sub>A</sub> =+25°C			T <sub>A</sub> =-40 to +85°C		Unit
				Min.	Typ.	Max.	Min.	Max.	
R <sub>FLAT(ON)</sub>	On Resistance Flatness <sup>(4)(5)</sup>	I <sub>OUT</sub> =100mA, nB0 or nB1=0V to V <sub>CC</sub>	4.30					0.25	Ω
			3.00					0.25	
			2.30		0.5				
			1.65		0.6				
R <sub>TERM</sub>	Internal Termination Resistors <sup>(6)</sup>				200				Ω
I <sub>CC</sub>	Quiescent Supply Current	V <sub>IN</sub> =0 or V <sub>CC</sub> , I <sub>OUT</sub> =0	4.30	-100		100	-500	500	nA
I <sub>CCCT</sub>	Increase in I <sub>CC</sub> per Input	Input at 2.6V	4.30		3			7	μA
		Input at 1.8V			7			15	

**Notes:**

2. On resistance is determined by the voltage drop between A and B pins at the indicated current through the switch.
3.  $\Delta R_{ON} = R_{ON\ max} - R_{ON\ min}$  measured at identical V<sub>CC</sub>, temperature, and voltage.
4. Flatness is defined as the difference between the maximum and minimum value of on resistance (R<sub>ON</sub>) over the specified range of conditions.
5. Guaranteed by characterization, not production tested, for V<sub>CC</sub>=1.65-3.00V.
6. Guaranteed by characterization, not production tested.

## AC Electrical Characteristics

All typical value are for  $V_{CC}=3.3V$  at  $25^{\circ}C$  unless otherwise specified.

Symbol	Parameter	Conditions	$V_{CC}$ (V)	$T_A=+25^{\circ}C$			$T_A=-40$ to $+85^{\circ}C$		Unit	Figure
				Min.	Typ.	Max.	Min.	Max.		
$t_{ON}$	Turn-On Time	nB0 or nB1=1.5V, $R_L=50\Omega$ , $C_L=35pF$	3.6 to 4.3			55	15	60	ns	Figure 8 Figure 9
			2.7 to 3.6			60	15	65		
			2.3 to 2.7			65	15	70		
			1.65 to 1.95		70					
$t_{OFF}$	Turn-Off Time	nB0 or nB1=1.5V, $R_L=50\Omega$ , $C_L=35pF$	3.6 to 4.3			30	5	35	ns	Figure 10
			2.7 to 3.6			35	5	40		
			2.3 to 2.7			40	5	45		
			1.65 to 1.95		40					
$t_{BBM}$	Break-Before-Make Time	nB0 or nB1=1.5V, $R_L=50\Omega$ , $C_L=35pF$	3.6 to 4.3		15		2		ns	Figure 14
			2.7 to 3.6		15		2			
			2.3 to 2.7		15		2			
			1.65 to 1.95		16		2			
Q	Charge Injection	$C_L=1.0nF$ , $V_S=0V$ , $R_S=0\Omega$	1.65 to 4.30		25				pC	Figure 12
OIRR	Off Isolation	$f=100kHz$ , $R_L=50\Omega$ , $C_L=0pF$	1.65 to 4.30		-70				dB	Figure 13
Xtalk	Crosstalk	$f=100kHz$ , $R_L=50\Omega$ , $C_L=0pF$	1.65 to 4.30		-70				dB	Figure 11
BW	-3db Bandwidth	$R_L=50\Omega$ , $C_L=0pF$	1.65 to 4.30		>50				MHz	Figure 17
THD	Total Harmonic Distortion	$f=20Hz$ to $20kHz$ , $R_L=32\Omega$ , $V_{IN}=2V_{pp}$	1.65 to 4.30		.06				%	

## Capacitance

Symbol	Parameter	Conditions	$V_{CC}$ (V)	$T_A=+25^{\circ}C$			Unit	Figure
				Min.	Typ.	Max.		
$C_{IN}$	Control Pin Input Capacitance	$f=1MHz$	0		1.5		pF	Figure 15
$C_{OFF}$	B Port Off Capacitance	$f=1MHz$	3.3		30		pF	Figure 15
$C_{ON}$	A Port On Capacitance	$f=1MHz$	3.3		120		pF	Figure 16

Test Diagrams

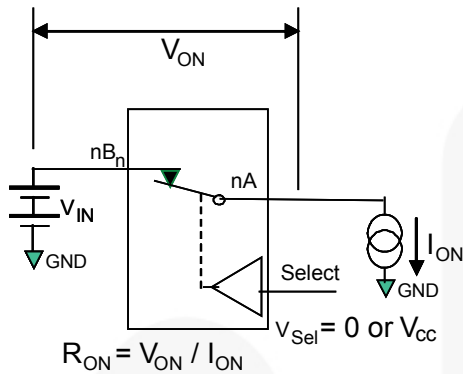
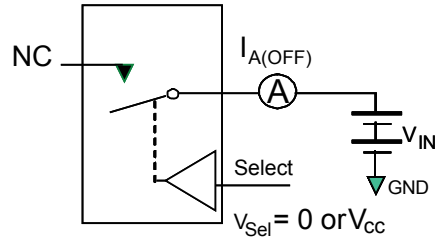


Figure 5. On Resistance



\*\*Each switch port is tested separately.

Figure 6. Off Leakage (Ports tested separately)

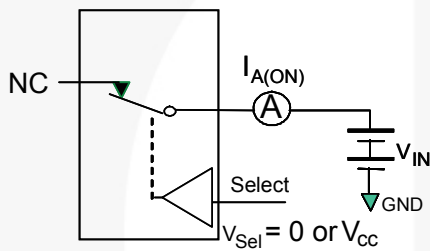


Figure 7. On Leakage

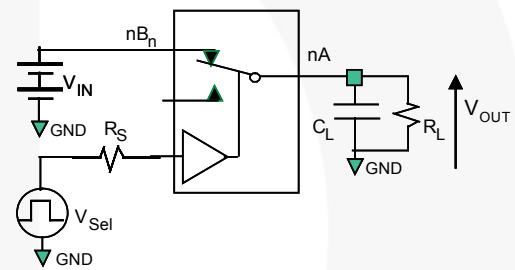


Figure 8. Test Circuit Load

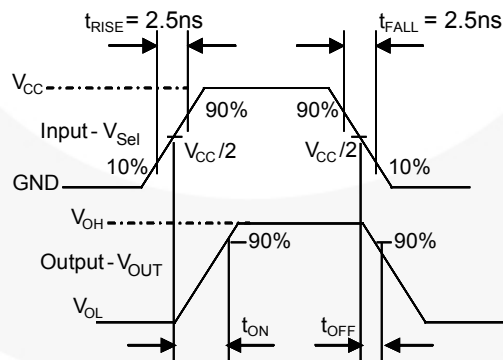
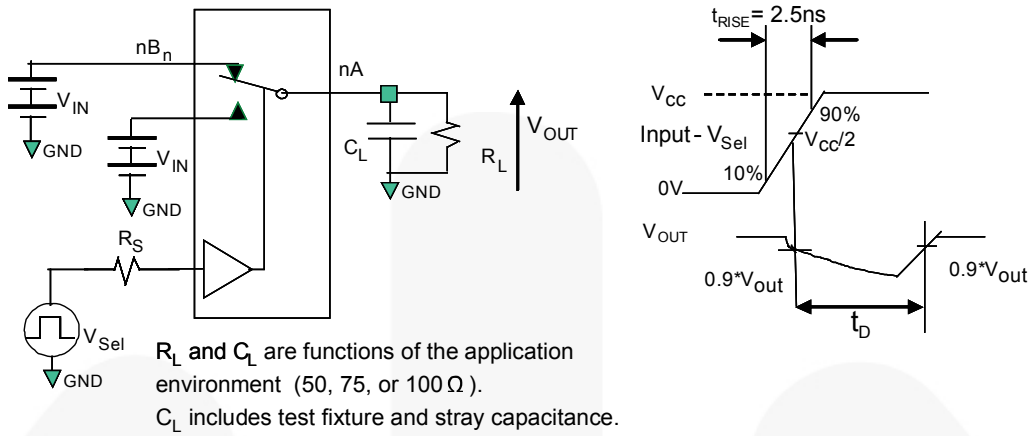
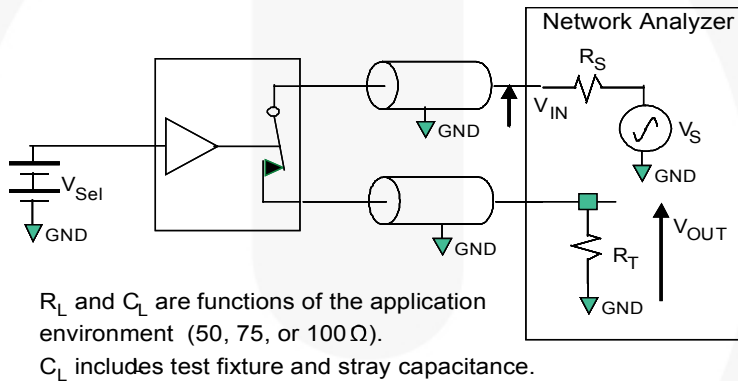


Figure 9. Turn-On / Turn-Off Waveforms

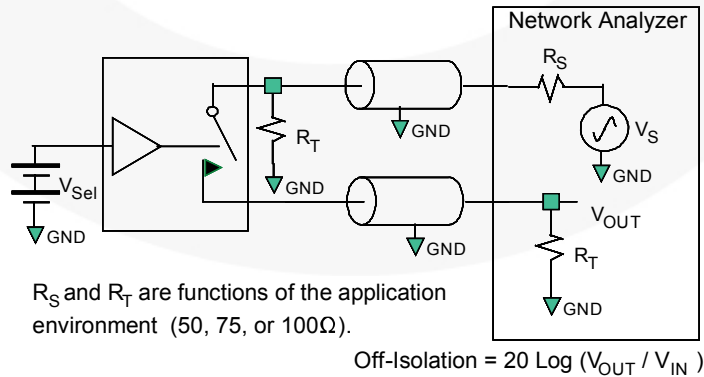
**Test Diagrams** (Continued)



**Figure 10. Break-Before-Make Interval Timing**



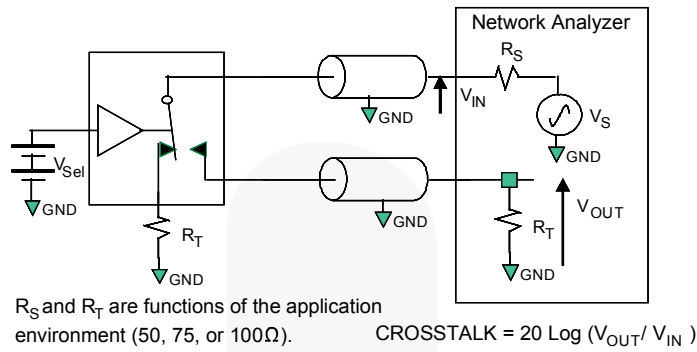
**Figure 11. Bandwidth**



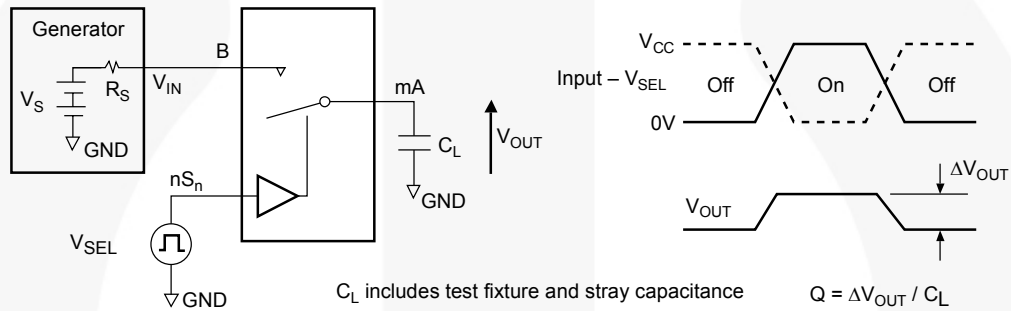
**Figure 12. Channel Off Isolation**



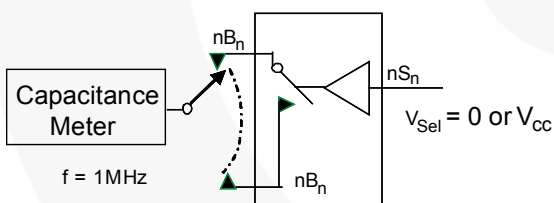
**Test Diagrams (Continued)**



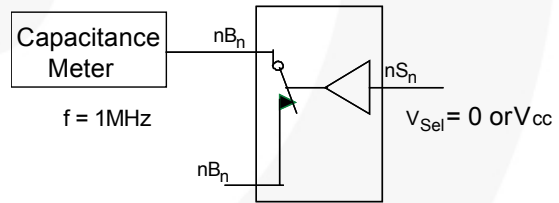
**Figure 13. Adjacent Channel Crosstalk**



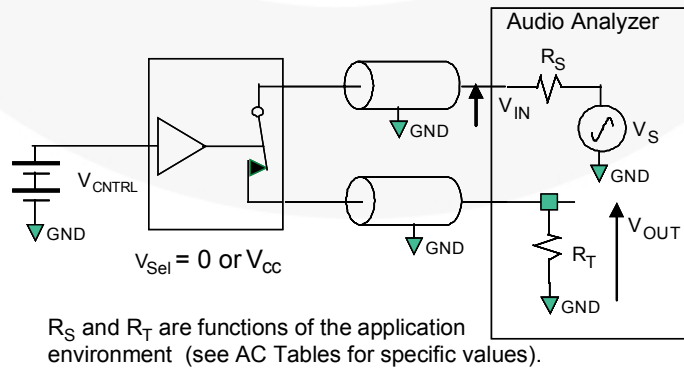
**Figure 14. Charge Injection Test**



**Figure 15. Channel Off Capacitance**

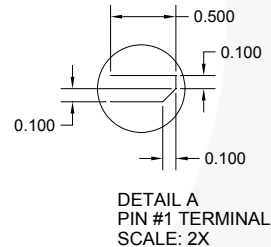
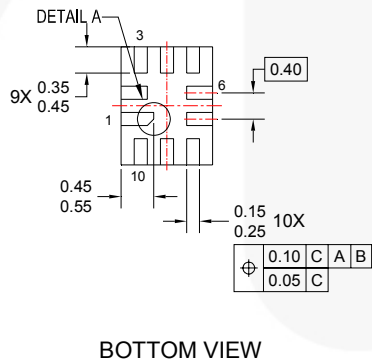
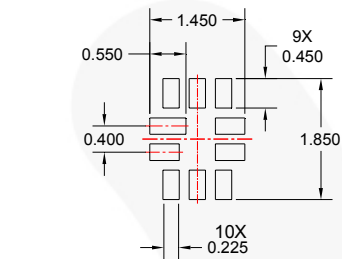
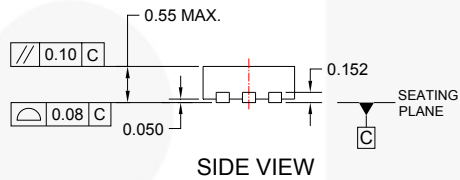
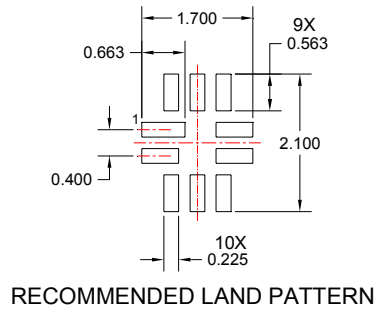
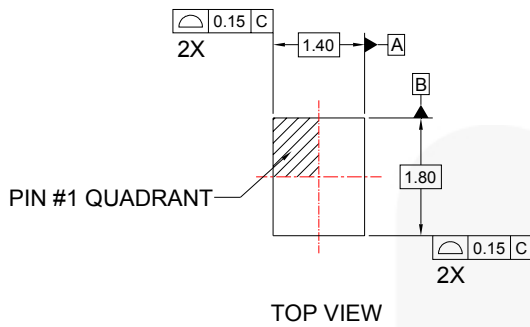


**Figure 16. Channel On Capacitance**



**Figure 17. Total Harmonic Distortion**

## Physical Dimensions



### NOTES:

- A. DIMENSIONS ARE IN MILLIMETERS.
- B. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994
- C. DRAWING FILENAME: UMLP10Arev2

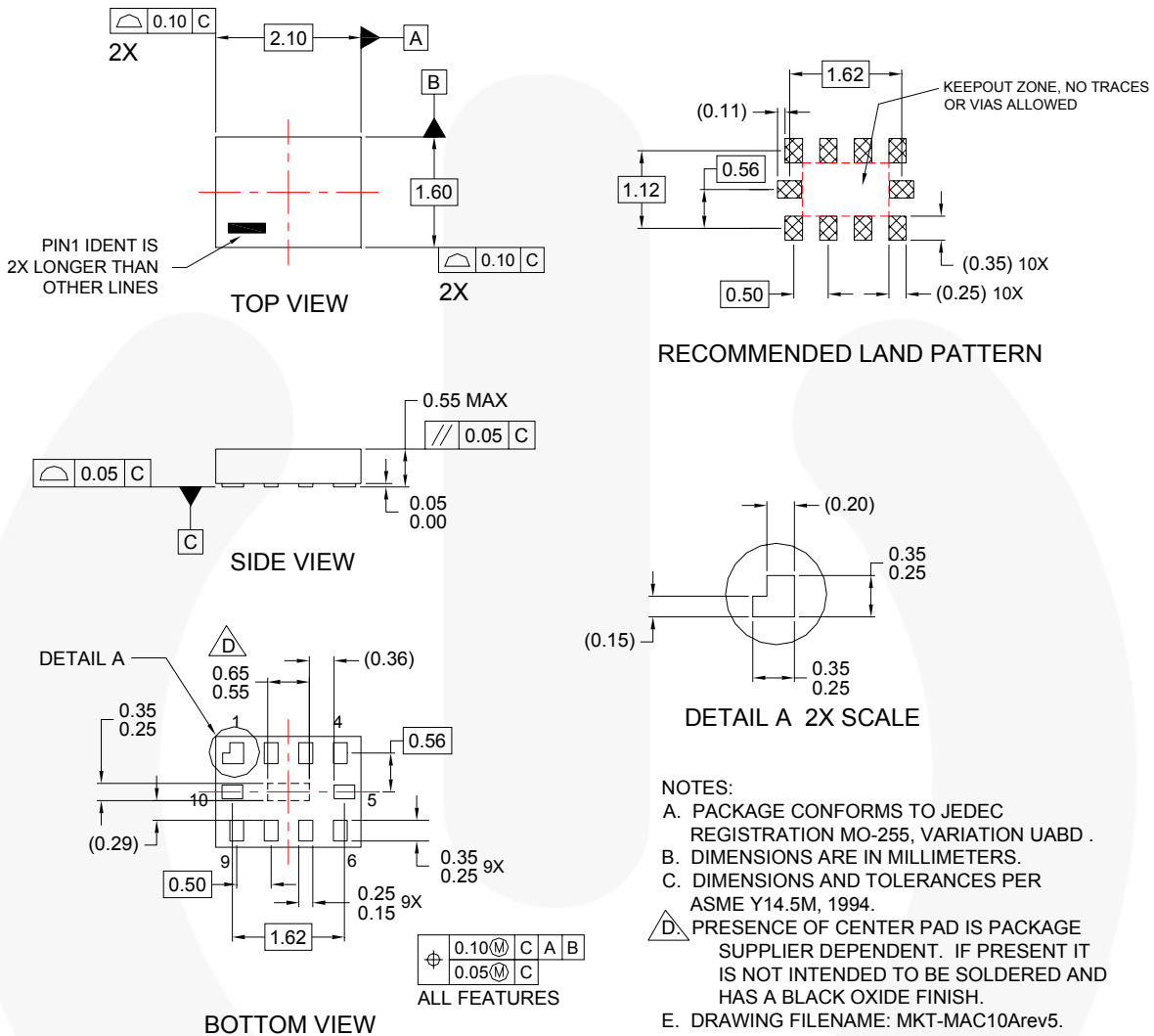
**Figure 18. 10-Lead Quad Ultrathin Molded Leadless Package (UMLP)**

**Note:** [click here for tape and reel specifications, available at: http://www.fairchildsemi.com/products/analog/pdf/UMLP10\\_TNR.pdf](http://www.fairchildsemi.com/products/analog/pdf/UMLP10_TNR.pdf)

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**Physical Dimensions (Continued)**



**Figure 19. 10-Lead, MicroPak™, 1.6mm Wide**

[Note: click here for tape and reel specifications, available at: http://www.fairchildsemi.com/products/logic/pdf/micropak\\_tr.pdf](http://www.fairchildsemi.com/products/logic/pdf/micropak_tr.pdf)

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FETBench™

FlashWriter®  
FPS™  
F-PFS™  
FRFET®  
Global Power Resource™  
Green FPS™  
Green FPST™ e-Series™  
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MicroPak™  
MillerDrive™  
MotionMax™  
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PowerXS™  
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QFET®  
QS™  
Quiet Series™  
RapidConfigure™  
Saving our world, 1mW/W/kW at a time™  
SignalWise™  
SmartMax™  
SMART START™  
SPM®  
STEALTH™  
SuperFET™  
SuperSOT™.3  
SuperSOT™.6  
SuperSOT™.8  
SupreMOS™  
SyncFET™  
Sync-Lock™

SYSTEM GENERAL®  
The Power Franchise®  
the power franchise®  
TinyBoost™  
TinyBuck™  
TinyCalc™  
TinyLogic®  
TINYOPTO™  
TinyPower™  
TinyPWM™  
TinyWire™  
TriFault Detect™  
TRUECURRENT™  
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2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

**ANTI-COUNTERFEITING POLICY**

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, [www.fairchildsemi.com](http://www.fairchildsemi.com), under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

**PRODUCT STATUS DEFINITIONS**

**Definition of Terms**

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. I43